

SF11G THRU SF17G

SUPER FAST RECOVERY GLASS PASSIVATED RECTIFIER

FEATURES:

- Low forward voltage drop
- High current capability
- High reliability
- High surge current capability

MECHANICAL DATA

Case : Molded plastic Epoxy: UL 94V-0 rate flame retardant Lead : Axial leads solderable per MIL-STD-202 Method 2028 guaranteed Polarity : Color band denotes cathode end Mounting Postition : Any Mounting Torque 5 In - Ibs.max Weight : 0.34 grams



DO-204AL/DO-41

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 $^{\circ}$ C ambient temperature unless otherwise specified. Single phase half wave, 60 Hz resistive or inductive load. For capacitive load. derate current by 20%.

Characteristic	Symbol	SF 11G	SF 12G	SF 13G	SF 14G	SF 15G	SF 16G	SF 17G	Units
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	Volts
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	Volts
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	Volts
Maximum average forward rectified current .375"(9.5mm) lead length at $Ta=55^{\circ}C$	I _(AV)	1.0						Amps	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30						Amps	
Maximum instantaneous forward voltage IF=1.0A	V _F	0.95			1.2	25	1.70	Volts	
Maximum DC reverse current $Ta=25^{\circ}C$ at rated DC blocking voltage $Ta=125^{\circ}C$	IR	5.0 100						uA	
Maximum reverse recovery time (NOTE 1)	T _{RR}	35						ns	
Typical Junction Capacitance(NOTE 2)	СЈ	50							PF
Operating temperature range	Tj	-65to+150							°C
Storage temperature range	T _{Stg}	-65to+175						°C	

NOTES :

1. Reverse recovery test condition : IF = 0.5A ; IR = 1.0A ; IRR = 0.25A

2.Measured 1MHZ and applied reverse voltage of 4.0VDC



RATINGS AND CHARACTERISTIC CURVES



150 25 50 75 100 125 175 AMBIENT TEMPERATURE.(℃)

FIG.3-TYPICAL FORWARD CHARACTERISTICS



FIG.4-TYPICAL REVERSE CHARACTERISTICS

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